

Tentative

TOSHIBA Photocoupler GaAs IRED + Photo-Triac

# **TLP261J**

: 600 V (min)

: 10 mA (max)

: 70 mA (max)

: 565 VpK

: 6000 Vpk

: 3000 Vrms (min)

: UL1577, file No. E67349

: EN60747-5-2 satisfied

**Triac Drivers Programmable Controllers AC-Output Modules** Solid-State Relays

The TOSHIBA mini-flat coupler TLP261J is a small-outline coupler suitable for surface mount assembly.

The TLP261J consists of a photo-triac optically coupled to a gallium arsenide infrared-emitting diode.

- Peak off-state voltage
- Trigger LED current •
- On-state current
- Isolation voltage
- Zero-crossing function
- UL-recognized
- Option (V4) type VDE-approved Maximum operating insulation voltage
  - Highest permissible overvoltage

Note: When an EN60747-5-2 approved type is needed, be sure to specify "Option (V4)".

Construction Mechanical Rating Creepage distance : 4.0 mm (min) Clearance 4.0 mm (min) Insulation thickness : 0.4 mm (min)

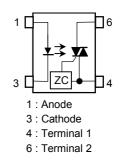
### Trigger LED Current

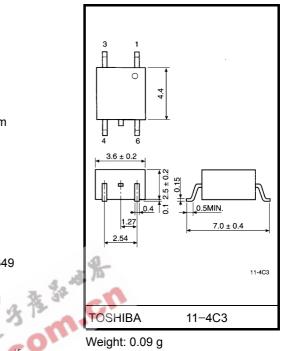
	Trigger LED	Product Classification		
Classification*	V <sub>T</sub> =3 V,			
	Min	Max	Marking	
(IFT7)	—	7	Т7	
Standard	—	10	T7, blank	

\*Ex. (IFT7); TLP261J (IFT7)

Note: Be sure to use standard product type names when submitting type names for safety certification testing, i.e., TLP261J (IFT7): TLP261J.

#### **Pin Configuration**





#### Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit	
	Forward current		lF	50	mA
	Forward current derating (Ta ≥ 53°C)		ΔI <sub>F</sub> / °C	-0.7	mA / °C
Peak forward current (100 µs pulse, 100 pps)		os)	I <sub>FP</sub>	1	А
	Reverse voltage		V <sub>R</sub>	5	V
	Junction temperature		Тј	125	°C
	Off-state output terminal voltage	V <sub>DRM</sub>	600	V	
	On-state RMS current	Ta = 25°C	I=	70	m (
		Ta = 70°C	I <sub>T(RMS)</sub>	40	mA
Detector	On–state current derating (Ta ≥ 25°C)		ΔI <sub>T</sub> / °C	-0.67	mA / °C
Det	Peak on-state current (100 µs pulse, 120 p	ps)	I <sub>TP</sub>	2	А
	Peak nonrepetitive surge current (PW = 10 ms, DC = 10%)		I <sub>TSM</sub>	1.2	A
	Junction temperature		Tj	100	°C
Stor	age temperature range	T <sub>stg</sub>	-55~125	°C	
Ope	rating temperature range	T <sub>opr</sub>	-40~100	°C	
Lead	d soldering temperature (10 s)		T <sub>sol</sub>	260	°C
Isola	ation voltage (AC, 1 min., R.H ≤ 60%)	(Note 1)	BVS	3000	Vrms

Note 1: Device considered as a two-terminal device: Pins 1 and 3 shorted together and pins 4 and 6 shorted together. .ed tog

#### **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур.	Мах	Unit
Supply voltage	VAC	_	—	240	Vac
Forward current	lF	15	20	25	mA
Peak on-state current	I <sub>TP</sub>	-	_	1	А
Operating temperature	T <sub>opr</sub>	-25	_	85	°C

#### Individual Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μA
	Capacitance	CT	V = 0, f = 1 MH <sub>Z</sub>	_	30	_	pF
	Peak off-state current	IDRM	V <sub>DRM</sub> = 600 V	—	10	1000	nA
	Peak on-state voltage	V <sub>TM</sub>	I <sub>TM</sub> = 70 mA	—	1.7	2.8	V
ctor	Holding current	Ι <sub>Η</sub>	—	—	0.6	_	mA
Detector	Critical rate of rise of off-state voltage	dv / dt	V <sub>in</sub> = 240 Vrms, Ta = 85°C (Fig. 1)	200	500	_	V/µs
	Critical rate of rise of commutating voltage	dv / dt(c)	V <sub>in</sub> = 60 Vrms, I <sub>T</sub> = 15 mA (Fig. 1)	_	0.2	_	V/µs

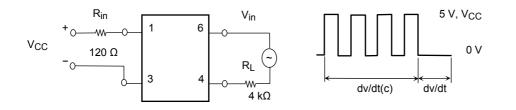
#### **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit	
Trigger LED current	I <sub>FT</sub>	V <sub>T</sub> = 3 V	—	—	10	mA	
Inhibit voltage	VIH	I <sub>F</sub> = Rated I <sub>FT</sub>	a —	—	20	V	
Leakage in inhibited state	Iн	I <sub>F</sub> = Rated I <sub>FT</sub> V <sub>T</sub> = Rated V <sub>DRM</sub>	5_	200	600	μA	
Turn-on time	ton	$V_D = 3 \rightarrow 1.5 \text{ V}, \text{ R}_L = 20 \Omega$ IF = rated IFT × 1.5		30	100	μs	
oupled Electrical Characteristics (Ta = 25°C)							

## Coupled Electrical Characteristics (Ta = 25°C)

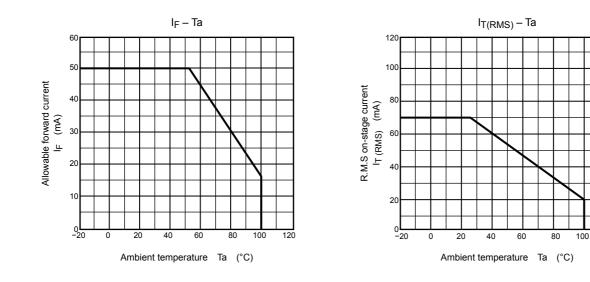
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance (input to output)	CS	∨ <sub>S</sub> = 0, f = 1 MH <sub>Z</sub>	_	0.8	_	pF
Isolation resistance	Rs	V <sub>S</sub> = 500 V, R.H. ≤ 60%	5×10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
	BVS	AC, 1 minute	3000	_	_	- V <sub>rms</sub>
Isolation voltage		AC, 1 second, in oil	_	5000	_	
		AC, 1 minute, in oil	_	5000	_	Vdc

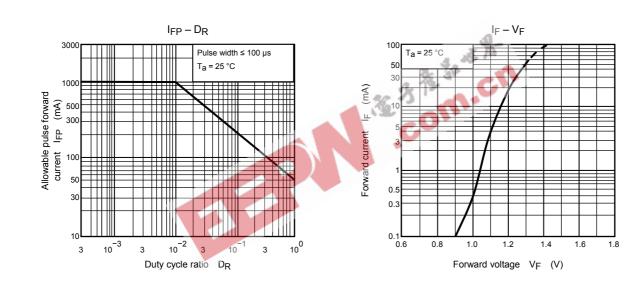
Fig. 1: dv / dt test circuit

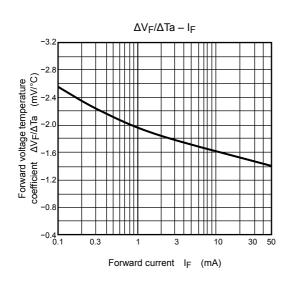


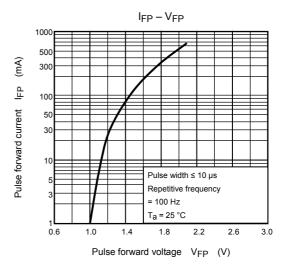
# **TOSHIBA**

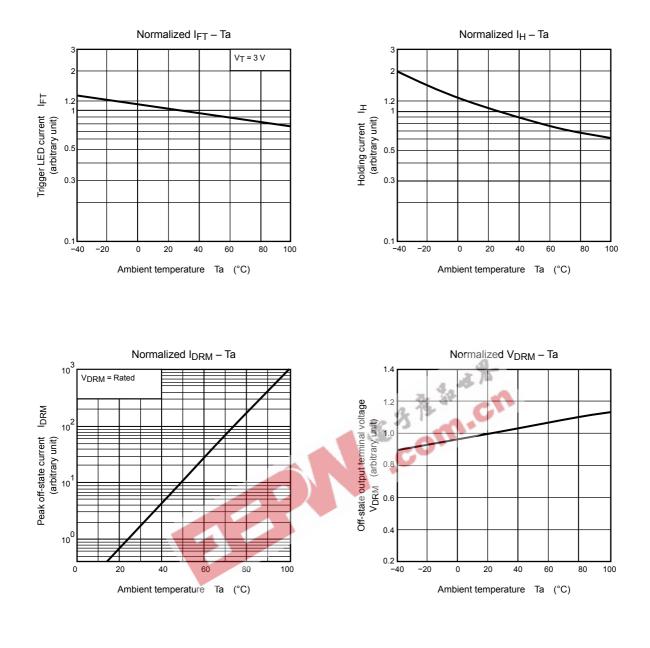
120

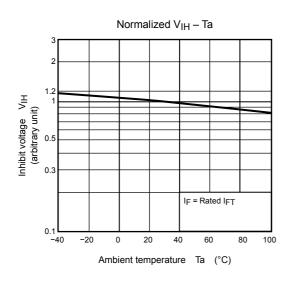












Normalized IIH - Ta 1.1 Inhibit current VIH (arbitrary unit) 0.5 0.3 IF = Rated IFT VT = Rated VDRM 0.1 -40 -20 0 20 40 60 80 100 Ambient temperature Ta (°C)

#### **RESTRICTIONS ON PRODUCT USE**

20070701-EN

- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
  In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in his document shall be made at the customer's own risk.
- The products described in this document shall not be used or embedded to any downstream products of which manufacture, use and/or sale are prohibited under any applicable laws and regulations.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patents or other rights of TOSHIBA or the third parties.
- GaAs(Gallium Arsenide) is used in this product. The dust or vapor is harmful to the human body. Do not break, cut, crush or dissolve chemically.
- Please contact your sales representative for product-by-product details in this document regarding RoHS compatibility. Please use these products in this document in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances. Toshiba assumes no liability for damage or losses occurring as a result of noncompliance with applicable laws and regulations.